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We claim:

- 1. A composition comprising;
 - A) a water soluble organic solvent,
 - B) a sulfonic acid or its corresponding salt, and
 - C) water.
- 2. The composition as claimed in claim 1, further comprising a corrosion inhibitor.
- 3. The composition as claimed in claim 1, wherein the water soluble organic solvent is monoethanolamine, N-methylethanolamine, dimethylsulfoxide, dimethylacetamide or mixtures thereof.
- 4. The composition as claimed in claim 1, wherein the sulfonic acid or its corresponding salt is p-to uene sulfonic acid, 1,5-naphthalene disulfonic acid, 4-ethylbenzene sulfonic acid, dodecylbenzene sulfonic acid or mixtures thereof.
- 5. The composition as claimed in claim 2, wherein the corrosion inhibitor is gallic acid, catechol, benzotriazole, benzoic acid, malonic acid, ammonium malonate or mixtures thereof.
- 6. A composition, comprising;
 - A) from 30 to 85 wt % of a water soluble organic solvent,
 - B) from 1 to 20 wt % of a sulfonic acid or its corresponding salt,
 - C) from 5 to 50 w/t % water.
- 7. The composition as claimed in claim 6, further comprising; from 0.1 to 15 wt % of a corrosion inhibitor.
- 8. A method of removing photoresist, etch and/or ash residue, or contaminants from a semiconductor substrate, comprising; contacting the semiconductor substrate with a composition, comprising:
 - A) a water soluble organic solvent,
 - B) a sulfonic acid or its corresponding salt, and
 - C) water;
- for a period of time sufficient to remove the photoresist, etch and/or ash residue, or contaminants.

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- 9. The method as claimed in claim 8, wherein the composition further comprises a corrosion inhibitor.
- 10. The method as claimed in claim 8, wherein the water soluble organic solvent is monoethanolamine, N-methylethanolamine, dimethylsulfoxide, dimethylacetamide or mixtures thereof.
- 11. The method as elaimed in claim 8, wherein the sulfonic acid or its corresponding salt is p-toluene sulfonic acid, 1,5-naphthalene disulfonic acid, 4-ethylbenzene sulfonic acid, dodecylbenzene sulfonic acid or mixtures thereof.
- 12. The method as claimed in claim 9, wherein the corrosion inhibitor is gallic acid, catechol, benzotriazole, benzoic acid, mallonic acid, ammonium malonate or mixtures thereof.